CERN Radiation Hardness Assurance: Challenges and Solutions for Large-Scale Distributed System Exposed to High-Energy Particle Accelerator Environments

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Introduction

- > At CERN, a large number of **COTS-based** systems are exposed to the LHC radiation environments
- > The reliability and the availability are a main concern for the CERN electronic equipment located in radiation areas
- > The **criticality** of the equipment can be very high, the radiation effects can lead to:
 - **Beam Dumps** \rightarrow Lost time for physics
 - LHC safety system failures → Part of the machine can be destroyed
- > In the LHC systems are affected by all radiation effects:
 - TID and DD:
 - \rightarrow Affect system lifetime (permanent failure)
 - \rightarrow Same failure probability for all units
 - SEE:
 - \rightarrow Stochastic system failure rate

\rightarrow Failure probability depends on number of systems



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@ Courtesy of the TE/MPE Group

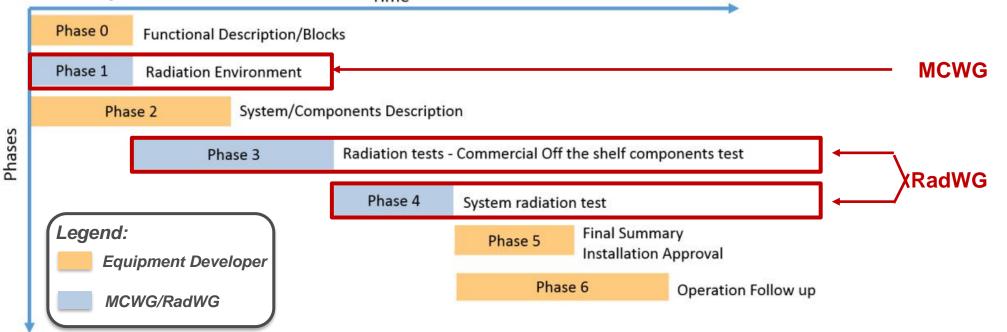
$$N_{SEE_Failure} = N * \sigma * fluence$$

Number of systems

Example: DQLPU = 530 units (Quench Protection unit system)

ATS-CERN RHA Guideline for COTS-based system

Radiation Hardness Assurance (RHA) Procedure for CERN AcceleraTor Sector (ATS) was developed to ensure reliability of radiation-tolerant developments and is based on ESA RHA and reliability methodologies Time



- Provide advices in early development stages for component choice lacksquare
- Help analyze system failure observed in operation or during system-level tests and propose mitigation techniques or part replacement candidates



Phase 1: Radiation Environment

Radiation levels at the electronic equipment locations are provided by the MCWG, in different way:

> **Previous Analysis** The values of radiation expected for HL-LHC are known for the most important locations of the machine and are available in released documents.

Measurements

Dosimeters are employed to carry out the measurements in the position of interest

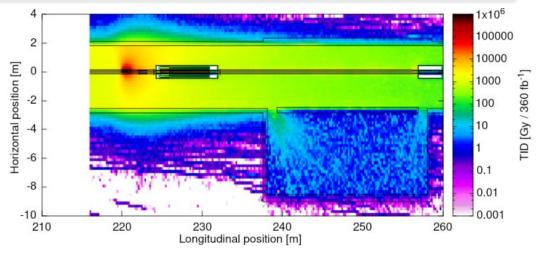
Simulation

When monitoring devices are not available, Expected radiation levels are evaluated through simulations

This information is the initial input that defines all primary requirements and the next qualification phases.



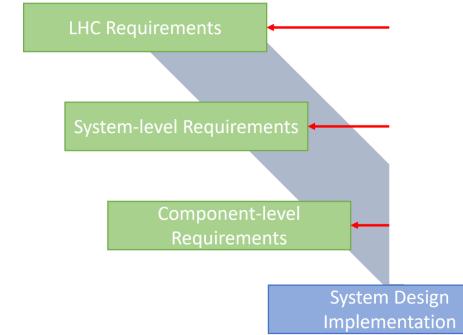
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Expected TID for HL-LHC in the x-z in RR17 G. Lerner. Radiation level specifications for hl-lhc. Technical report, CERN EDMS document, https://edms.cern.ch/document/2302154/1.0, Geneva, CH, 2020.

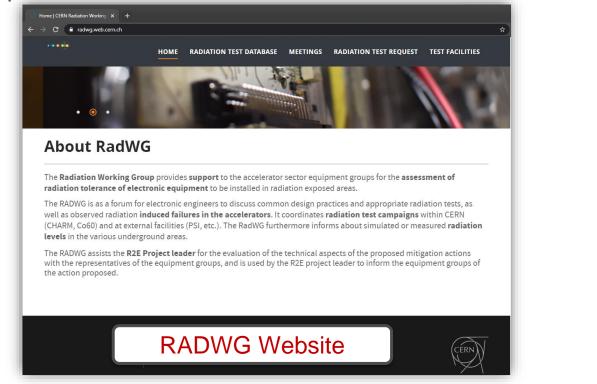


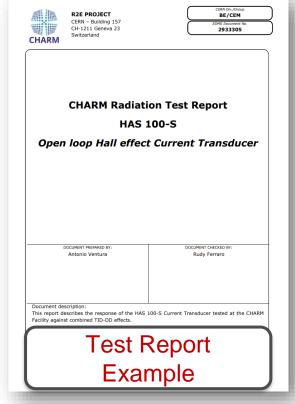
- In Phase 2, availability and reliability requirements at the system and component-level are defined based on the LHC Requirements established also through Phase 1.
- The definition of the requirement tailors the design choices but not only!
- The component and system-level qualification phase are strictly interconnected with this Phase: the requirements defined during this step define the constraints that will be necessary to meet during the qualification stages.





A database of Radiation-Tolerant components maintained by the Radiation Working Group (RadWG) is made available to the Equipment groups to select the component meetings their project and radiation tolerance requirements:





If no components fits the system's requirements new candidates should be qualified



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- The target availability for HL-LHC is 0.1 dumps/fb-1 \rightarrow whole machine.
 - A conservative approach is followed defining the dumps/fb-1 allowed for each system. It has been estimated that the number of units capable of inducing a beam dump is in the order of ten thousand and thus, its unit should produce 10-5 dumps/fb-1.
 - The environment that the system will have to withstand is known from Phase1 and can be used to evaluate the respect of the margins.

ID	Requirements
LHC-R001	Each system in the LHC can cause 10^{-5} dump fb

By multiplying the corresponding expected fluence per fb by system Th and HEH cross-sections \rightarrow expected failure rate per fb is obtained.

Within the specs, DEV-A003 best choice



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- The assessment of compliance with the reliability constraints is simpler. The TID and DDEF margins are adjusted by taking into account the expected radiation value of the operating area foreseen in Phase 2 for the whole lifetime of the accelerator (12 years).
- The radiation design margins, where RDM >2 is possible, are taken into account to reflect the statistical distribution of radiation responses of equipment of the same LOT.

ID	Requirements
LHC-R001	In UJ16 are expected 144 Gy in 12 years of operation of HL-LHC
LHC-R002	In UJ16 are expected $6 \cdot 10^{11}$ MeV neq. cm^{-2} in 12 years of operation of HL-LHC
SYS-R001	Considering RDM of 3, all the components have to remain within the defined specs after absorbing 432 Gy and $1.8 \cdot 10^{12}$ MeV neq. cm^{-2}
SYS-R002	The 1.2 V DC-DC converter shall not deviate more than $\pm 10\%$ to not compromise the functionalities of the system
DEV-A001	This DC-DC converter stopped working after cumulated 200 Gy and $3.2 \cdot 10^{11}$ MeV neq. cm^{-2}
DEV-A002	At the RDM, the device was functional but the output was deviated of -12 $\%$
DEV-A003	At the RDM, the device did not exhibit any degradation remain- ing within the specs



Phase 3: COTS components level testing

		SEE	TID	DD
Semiconductor Materials	Si / SiO2 III-V Compounds (GaAs)	Charge collection Carrier drift Depletion area extension	ΔΝΟΤ, ΔΝ _{ΙΤ}	Minority carrier decrease Carrier removal Current leakage
Active Elementary Devices	Transistor:MOSFETBipolarDiodes:ZenerLEDSchottky	SET, SEB, SEGR, SEL SET SET SET SET, SEB	$\begin{array}{c} \Delta V_{TH} \\ \Delta H_{CE}, \Delta I_{CE}, \Delta I_{BE}, \Delta V_{BE} \\ \Delta V_{F,} \Delta I_{L} \\ \Delta V_{F}, \Delta P_{,} \Delta I_{L} \\ \Delta V_{F,} \Delta I_{L} \end{array}$	- ΔΗ _{CE} , ΔΙ _{CE} , ΔΙ _{BE} , ΔV _{BE} ΔV _F , ΔΙ _L ΔV _F , ΔΡ _, ΔΙ _L ΔV _F , ΔΙ _L
Integrated Circuits	Digital:Memory FPGA μControllerAnalog:Opamp RegulatorsMixed:ADC DAC Smart PowerOptronics:Smart Power Optocoupler PhotoMOS	<pre> } SEU, SEFI, SEL, MBU } SET, SEL SEU, SEFI, SEL, MBU,SET } SET</pre>	$\begin{array}{c} \Delta I_{CC} \\ \Delta I_{CC,} \Delta t_{PD}, programma bility \\ \Delta I_{CC,} \Delta V_{REF} \\ \Delta v_{off}, \Delta I_{BIAS}, \Delta G, \Delta I_{quiescient} \\ \Delta I_{CC}, \Delta V_{REF}, \Delta V_{START} \\ \Delta I_{CC}, \Delta V_{REF}, \Delta_{ENOB} \\ \Delta I_{CC}, \Delta V_{REF}, \Delta_{ENOB} \\ \Delta I_{CC}, \Delta V_{REF}, \Delta_{ENOB} \\ \Delta I_{CC}, \Delta T_{P} \\ \Delta CTR, \Delta I_{TH} \\ \Delta I_{TH,} \\ Switch capability \end{array}$	- - $\Delta v_{off}, \Delta I_{BIAS}, \Delta G, \Delta i_{quiescient}$ $\Delta I_{CC}, \Delta V_{REF}, \Delta V_{START} \dots$ - - ΔT_{P} $\Delta CTR, \Delta I_{TH}$ ΔI_{TH}
SoC Systems	Can contains all the above	Destructive events Temporary failures Permanent fault states	Performance Parametric d	0



Phase 3: COTS components level testing

			SEE	TID	DD
Active Elementary Devices	Transistor:MOSFETBipolarDiodes:LEDSchottl	···· N	MIL-STD-750, SEB/SEGR ESCC25100	ESCC22900 (ELDR) MIL-STD 883 1019.8 MIL-STD750E 1019.5 ASTM F 1892-06	No standard yet but guidelines
Integrated Circuits	FPGA μContr Analog: Opam Regula Mixed: ADC DAC Smart Optronics: Optoco	l: Memory FPGA μController g: Opamp Regulators : ADC DAC Smart Power hics: Optocoupler		adiation Environment", NASA	oupler Usage in the Space Radiation Testing", NASA
SoC Systems	Can contains all above	71, 601	H. Quinn, "Challenges ronetti et al., "Radiation Hardnes Requirements, Test N kowski et al., "Comparison of the	nes exist (with a big contribution in Testing Complex Systems,"in IEEE as Assurance Through System-Level To Methodology, and Data Exploitation," e Total Ionizing Dose Sensitivity of a So onent- and System-Level Test Approace	TNS, April 2014 esting: Risk Acceptance, Facility IEEE TNS 2021 System in Package Point of Load



Phase 3: CERN Specific Radiation Qualification Challenges

 In order to obtain more realistic results and to improve the qualification phase at component level, CERN has developed its own guidelines specific to its radiation environment.





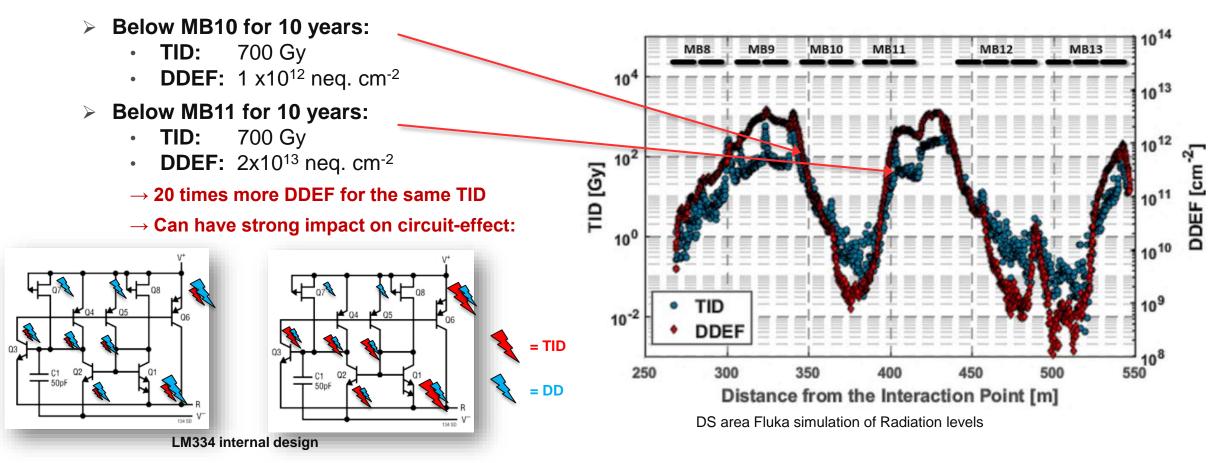
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Phase 3: Challenge Example - Impact of LHC TID/DD levels

- > In terms of TID-DD effects, the LHC environment present a unique challenge:
 - Depending on the areas, a same system can experience different radiation levels:

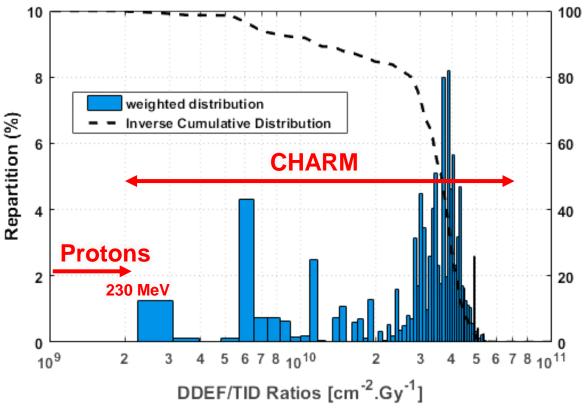




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Phase 3: Challenge Example - Impact of LHC TID/DD levels

- > In terms of TID-DD effects, the LHC environment present a unique challenge:
 - Depending on the areas, a same system can experience different radiation levels:
 - > Below MB10 for 10 years:
 - **TID:** 700 Gy
 - **DDEF:** 1 x10¹² neq. cm⁻²
 - > Below MB11 for 10 years:
 - **TID:** 700 Gy
 - **DDEF:** 2x10¹³ neq. cm⁻²
 - \rightarrow 20 times more DDEF for the same TID
 - Wide variety of DDEF/TID Ratio:
 - From **10**⁹ up to **10**¹¹ cm⁻².Gy⁻¹
 - → Can lead to various degradation profiles for devices sensitive to combined TID-DD



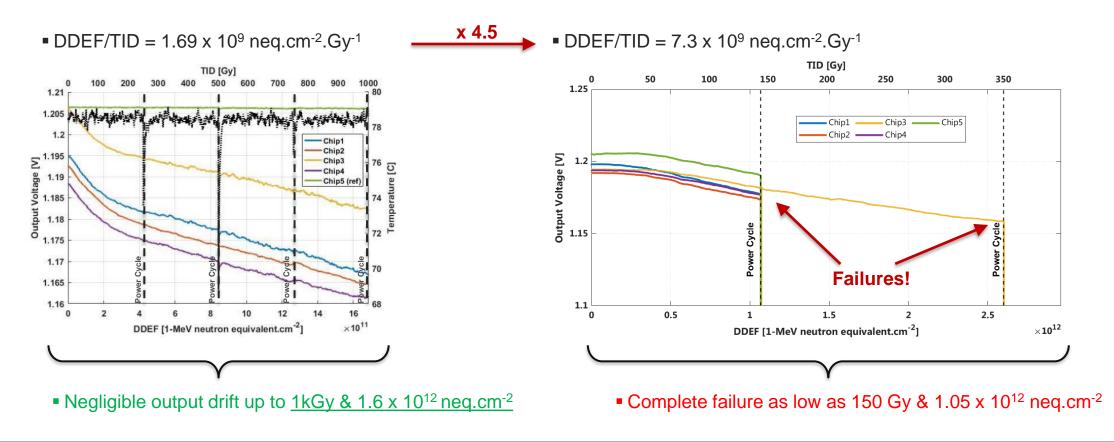
R. Ferraro *et al.*, "Study of the Impact of the LHC Radiation Environments on the Synergistic Displacement Damage and Ionizing Dose Effect on Electronic Components," in *IEEE Transactions on Nuclear Science*, <u>link</u>



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Phase 3: Challenge Example - Impact of LHC TID/DD levels

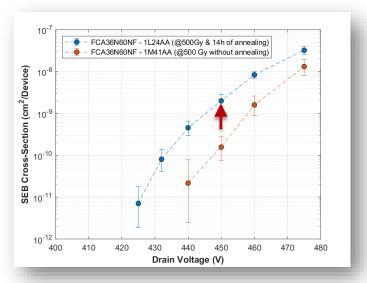
- > Example of a regulator exhibiting different failure degradation rate in different DDEF/TID ratio conditions:
- > LM3083 Adjustable Positive Voltage Regulator:





Phase 3: Challenge Example – lot-to-lot variation

Devices can exhibit different radiation sensitivities from lot to lot:



Single Event Effects:

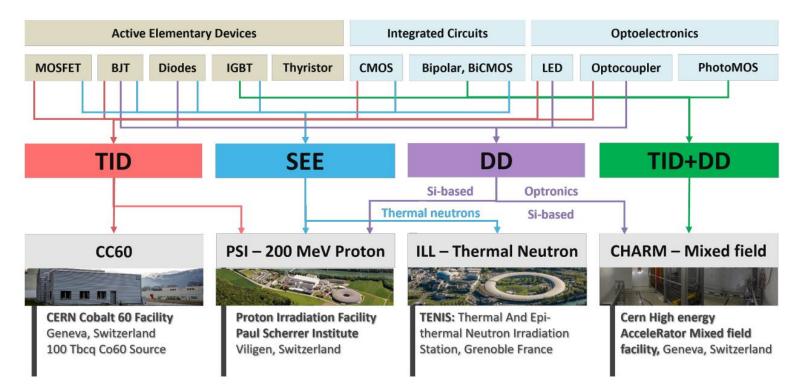
For same drain voltage, cross section 10 times higher!

- If enough samples are tested a single lot variability is usually small enough to meet Radiation Design Requirements (RDR)
- Every production lots should be qualified against radiation
- Procuring single lots for multiple projects allow for reducing overall qualification cost, resources and efforts



Phase 3: COTS components level testing

All specific challenges and methodologies are combined and address in the CERN RHA procedure and the overall facility selection methodology for the different kinds of components is the following:





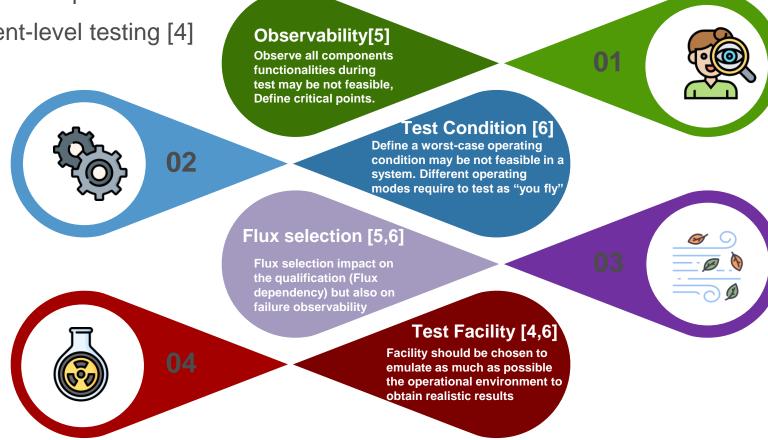
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Phase 4: COTS System level testing - challenges

- For CERN system-level testing is not optional
- It is complementary to Component-level testing [4]

The different publications developed in recent years make it possible to improve this phase and provide guidelines on how to overcome these challenges.

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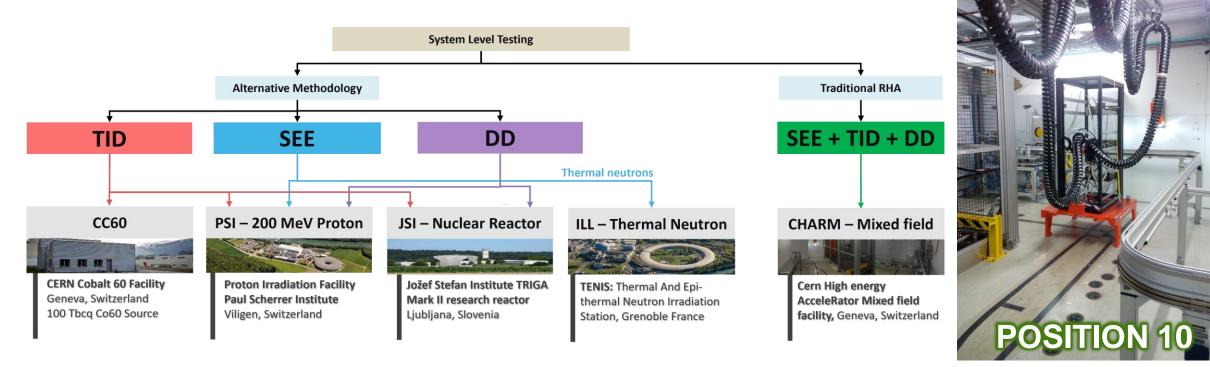




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Phase 4: COTS System level testing - strategies

- CERN RHA foresees qualification of system in CHARM-facility. This facility offers the possibility of testing complete electronic systems in a realistic field, fully representative of the mixed-field environment of the high-energy accelerator.
- Its unavailability during LHC Long Shut-down (LS) pushed to the development of alternative methodology capable to provide the advantages of system-level testing.





Phase 5: Installation Approval

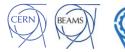
 Once all the qualification is performed, a System Radiation Hardness Project Validation document is filled to demonstrate the system reliability against Radiation:

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angineering a characteri				Pa	ge 2 of 24	
Radiation Hard	ness Assu	ance Proto	col Docur	nent		
	olerant electronics	for vacuum instrume				
	Brief description	of the project(s):				
The vacuum gauge electronics currently ins not endure the expected cumulative dose is lectronics thus need to be replaced by radi n order to comply with the requirements for and risks in case of an intervention, as the ease the access process and ensure the sa re	evels (TID) for RUN ation tolerant elect or radiation tolerand electronics are fixe ifety during mainte	3 in the DS areas for ronics during LS2 for e. Furthermore, the d within the VRJGE I	the HL-HLC era i the DS areas and current installatio boxes located abo the new electroni	n the arc d during l n impose ve the Q	s. The existing LS3 for the arcs complications RL. In order to	
EQUIPMENT CONCERNED:	DRAWINGS	CONCERNED:	DOCUME	VTS CON	CONCERNED:	
PE IN CHARGE OF THE ITEM	:	PROJECT LEADER:				
G. Pigny		R. Garcia Alia				
DECISION OF THE PROJECT ENGI	NEER:	DECISION OF THE PROJECT LEADER:				
Accepted by the Project Engineer,		Accepted by the Project Leader.				
no impact on other items.		a necepted by	the moject cos			
Actions identified by the Project Engineer						
Accepted by the Project Engineer,						
but impact on other items.						
Comments from other Project Engineers	required.					
Final decision and actions by the Project	Management.					
			001111 01 100 1			
DATE OF APPROVAL: 01/06/2019	ACTIONS TO BE		ROVAL: 01/06/2	019		
DATE OF IMPLEMENTATION: DURIN	G THE SECOND LO	NG SHUTDOWN				
Note: When approved, an Engl	neering Change R	equest becomes an E	ingineering Chang	ge Order		

The Document contains:

- Project Description
 - Technical requirements
 - Criticality
 - Architecture
 - Equipment EDAs
- Equipment Locations & Radiation Environments
- Radiation Tolerance
 - System/Components Radiation failure modes
 - Component-level qualification
 - System-level qualification
- Linked to the Engineering Change Request (ECR) as final validation
 - Check-box in ECR template for electronics installed in possible radiation area

Example of RHAPV Document



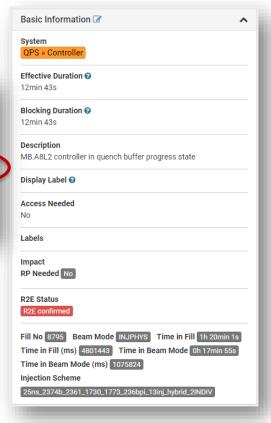
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Phase 6: Operation Follow-up

During operation RHA activities are still ongoing, confirmed or suspected radiation-induced failures are reported on the Accelerator Fault Tracking webtool (aft.cern.ch) and are follow-up with mitigation actions, such as replacement, new system revision etc...

Ì	Accelerator Fault Tracking	Accel	lerators	Time period 7 Months before Previous Monday at 09:00			Excluded time periods - Clear all					
	Dashboard		Accelerato	v System	 Start Time 	~	End Time 🛛 🗸	OP Duration	Effective Duratic 🗸	States ~	R2E Status ~	
•			T Filter	T Filter	T Filter		T Filter	▼ Filter	T Filter	T Filter	C Filter	
	Register fault		LHC	QPS » Controller	20-05-2023 03:	36:42	20-05-2023 03:49:25	12min 43s	12min 43s		R2E confirme	
Q	Search faults		LHC	QPS » Controller	20-05-2023 07:	54:10	20-05-2023 12:19:42	04h 25min 32s	04h 25min 32s		R2E candidate	
l ulu s	Statistics		LHC	Cryogenics » Users » Quench	18-09-2023 06:4	49:39	18-09-2023 10:07:21	03h 17min 42s	03h 17min 42s		Not R2E relat	
			HC HC	Magnet circuits » Training Que	18-00-2023 060	10.38	18-00-2023 06-40-30	01s	A 03h 17min //3s		Not R2F relate	

- The failure rate and degradation observed during operation are continuously compared with the estimated values.
- These comparisons allow the validation of the RHA process, but also its extension if unexpected anomalies are observed.





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Conclusion

- In this presentation the CERN Radiation Hardness Assurance (RHA) Procedure was introduced through an overview of the different Phases constituting it.
- The different approaches used to perform the radiation analysis of the LHC environment (Phase 1) were presented.
- The definition of the system requirements (phase 2) and CERN Radiation Database were outlined.
- The different challenges related to the LHC radiation environment required the development of specific methodologies to obtain more <u>realistic possible results</u>.
 - An example of these methodologies (DDEF/TID ratio impact on degradation rates) was given.
- The **importance of system-level** testing from a CERN perspective was discussed:
 - The challenges are addressed by CERN's approach. However, ongoing studies will improve this phase.
- Once qualified, the system is followed up to verify the effectiveness of the approach.
- The CERN RHA is nowadays a mandatory procedure for all systems installed in no-safe areas



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Reference

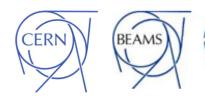
- A. Scialdone, R. Ferraro, R. G. Alía, L. Sterpone, S. Danzeca and A. Masi, "FPGA Qualification and Failure Rate Estimation Methodology for LHC Environments Using Benchmarks Test Circuits," in *IEEE Transactions on Nuclear Science*, vol. 69, no. 7, pp. 1633-1641, July 2022, doi: 10.1109/TNS.2022.3162037.
- R. Ferraro *et al.*, "COTS Optocoupler Radiation Qualification Process for LHC Applications Based on Mixed-Field Irradiations," in *IEEE Transactions on Nuclear Science*, vol. 67, no. 7, pp. 1395-1403, July 2020, doi: 10.1109/TNS.2020.2972777.
- R. Ferraro, R. G. Alía, S. Danzeca and A. Masi, "Analysis of Bipolar Integrated Circuit Degradation Mechanisms Against Combined TID–DD Effects," in *IEEE Transactions on Nuclear Science*, vol. 68, no. 8, pp. 1585-1593, Aug. 2021, doi: 10.1109/TNS.2021.3082646.
- 4) A. Coronetti *et al.*, "Radiation Hardness Assurance Through System-Level Testing: Risk Acceptance, Facility Requirements, Test Methodology, and Data Exploitation," in *IEEE Transactions on Nuclear Science*, vol. 68, no. 5, pp. 958-969, May 2021, doi: 10.1109/TNS.2021.3061197.
- Alessandro Zimmaro, Rudy Ferraro, Jérôme Boch, Frédéric Saigné, Rubén García Alía, Alessandro Masi, and Salvatore Danzeca. Radiation test flux selection methodology to optimize see observability on systems with different operating modes. In 2022 22th European Conference on Radiation and Its Effects on Components and Systems (RADECS), pages 1–8, 2023
- 6) A. Zimmaro *et al.*, "Testing and Validation Methodology for a Radiation Monitoring System for Electronics in Particle Accelerators," in *IEEE Transactions on Nuclear Science*, vol. 69, no. 7, pp. 1642-1650, July 2022, doi: 10.1109/TNS.2022.3158527..



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Thank you for your attention!



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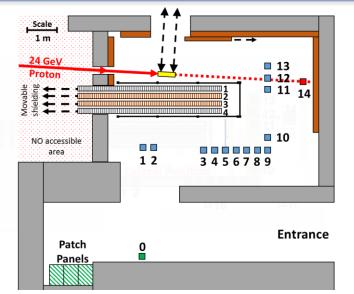
CHARM Mixed Field Facility

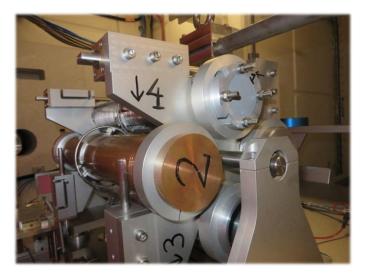
- Primary 24 GeV proton beam coming from PS impinges a target
- Secondary radiation fields similar to the LHC radiation fields.
- Radiation field can be modulated with:



Shielding:
 C - Concrete (1,4)
 I - Iron (2,3)

Positions: Lateral (1:9) Longitudinal (9:13)





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